

DIGITRON SEMICONDUCTORS

MCR101-MCR104

SILICON CONTROLLED RECTIFIERS

Available Non-RoHS (standard) or RoHS compliant (add PBF suffix).

Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.

MAXIMUM RATINGS ($T_C = 85^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak reverse blocking voltage MCR101 MCR102 MCR103 MCR104	V_{RRM}	15 30 60 100	Volts
Forward current RMS (all conduction angles)	$I_{T(RMS)}$	0.8	Amps
Peak forward surge current (1/2 cycle, sine wave 60 Hz, $T_A = 25^\circ\text{C}$)	I_{TSM}	6.0	Amps
Circuit fusing considerations ($t = 1$ to 8.3ms, $T_A = 25^\circ\text{C}$)	I^2t	0.15	A^2s
Forward peak gate power ($T_A = 25^\circ\text{C}$)	P_{GM}	0.1	Watts
Forward average gate power ($T_A = 25^\circ\text{C}$)	$P_{G(AV)}$	0.01	Watts
Forward peak gate current ($T_A = 25^\circ\text{C}$, 300 μs , 120PPS)	I_{GM}	1.0	Amps
Reverse peak gate voltage	V_{GM}	4.0	Volts
Operating junction temperature range @ rated V_{RRM} and V_{DRM}	T_J	-65 to +85	$^\circ\text{C}$
Storage temperature range	T_{stg}	-65 to +150	$^\circ\text{C}$
Lead solder temperature (<1/16" from case, 10 sec. max.)	-	+230	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal resistance, junction-to-case	$R_{\theta JC}$	75	$^\circ\text{C}/\text{W}$
Thermal resistance, junction-to-ambient	$R_{\theta JA}$	200	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS ($R_{GK} = 1000\Omega$)

Characteristic	Symbol	Min	Max	Unit
Peak forward blocking voltage⁽¹⁾ ($T_C = 85^\circ\text{C}$) MCR101 MCR102 MCR103 MCR104	V_{DRM}	15 30 60 100	- - - -	Volts
Peak forward blocking current (Rated V_{DRM} @ $T_C = 85^\circ\text{C}$)	I_{DRM}	-	100	μA
Peak reverse blocking current (Rated V_{RRM} @ $T_C = 85^\circ\text{C}$)	I_{RRM}	-	100	μA
Forward "on" voltage⁽²⁾ ($I_{TM} = 1.0\text{A}$ peak @ $T_A = 25^\circ\text{C}$)	V_{TM}	-	1.7	Volts
Gate trigger current (continuous dc) ⁽³⁾ ($V_{AK} = 7\text{Vdc}$, $R_L = 100\Omega$, $T_C = 25^\circ\text{C}$)	I_{GT}	-	200	μA
Gate trigger voltage (continuous dc) ($V_{AK} = 7\text{Vdc}$, $R_L = 100\Omega$) $T_C = 25^\circ\text{C}$ $T_C = -65^\circ\text{C}$ $T_C = 85^\circ\text{C}$	V_{GT} V_{GD}	- 0.1	0.8 - -	Volts
Holding current ($V_{AK} = 7\text{Vdc}$, initiating current = 20mA) $T_C = 25^\circ\text{C}$ $T_C = -65^\circ\text{C}$	I_H	- -	5.0 10	mA

Note 1: V_{DRM} and V_{RRM} for all types can be applied on a continuous dc basis without incurring damage. Ratings apply for zero or negative gate voltage but positive gate voltage shall not be applied concurrently with a negative potential on the anode. When checking forward or reverse blocking capability, thyristor devices should not be tested with a constant current source in a manner that the voltage applied exceeds the rated blocking voltage.

Note 2: Forward current applied for 1.0 ms maximum duration, duty cycle $\leq 1.0\%$.

Note 3: R_{GK} current is not included in measurement.

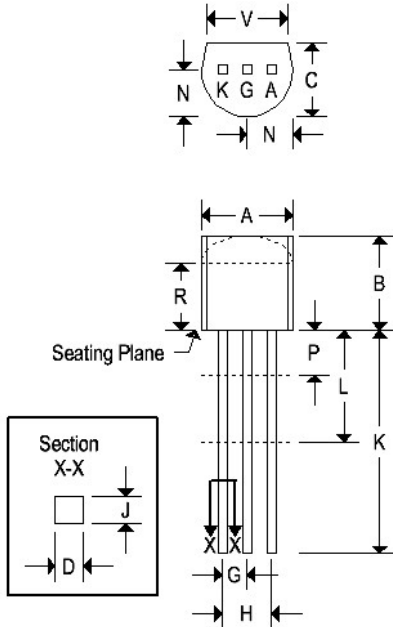
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MECHANICAL CHARACTERISTICS

Case	TO-92
Marking	Alpha-numeric
Pin out	See below



	TO-92			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.175	0.205	4.450	5.200
B	0.170	0.210	4.320	5.330
C	0.125	0.165	3.180	4.190
D	0.016	0.022	0.410	0.550
F	0.016	0.019	0.410	0.480
G	0.045	0.055	1.150	1.390
H	0.095	0.105	2.420	2.660
J	0.015	0.020	0.390	0.500
K	0.500	-	12.700	-
L	0.250	-	6.350	-
N	0.080	0.105	2.040	2.660
P	-	0.100	-	2.540
R	0.115	-	2.930	-
V	0.135	-	3.430	-

FIGURE 1 - CURRENT DERATING
(REFERENCE: CASE TEMPERATURE)

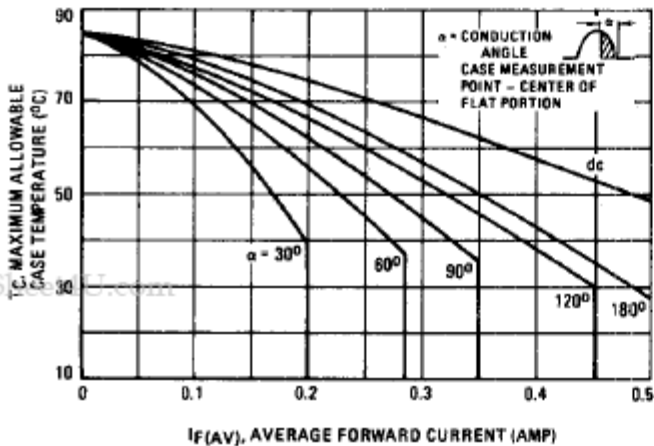


FIGURE 2 - CURRENT DERATING
(REFERENCE: AMBIENT TEMPERATURE)

